

<u>AN577</u>

PIC16C54A EMI Results

INTRODUCTION

This paper discusses the EMI results of the PIC16C54A. These measurements were taken by an independent consulting firm that specializes in electromagnetic testing. These results are for a specific system design, each design will have its own results.

DEVICES USED

These tests were done on a random PIC16C54A device, and should be considered as typical results. Initial testing was done on three boards / devices. The device frequency of the boards were, respectively, 32 KHz, 4 MHz, and 20 MHz. As would be expected there was a substantial difference (decrease) at the low frequency as compared to the higher frequencies. The difference between the 4 MHz operation and the 20 MHz operation was marginal. The final testing of the device was done at 4 MHz, and was according to the FCC measurement procedure MP-4.

SYSTEM USED

The PIC16C54A device was tested in the Microchip OHMMETER board. This board is a three layer board, with a ground plane. Power and ground planes greatly help in the compliance of designs to the FCC part 15 subpart B testing. This board had minimal other external components, so that the electromagnetic measurements could mostly be attributed to the device and design of the system. To reduce the noise that comes from a power supply, a 10 nF bypass capacitor was attached to the power / ground of the input jack.

EMI TESTING

The testing of electromagnetic noise (EM) on a system has two types of commonly used testing environments, an internal and external environment. The internal test is done is a screen room to reduce the amount of stray EMI. The indoor tests is useful in determining the source of EMI radiation. The external test is done outdoors. This places the equipment under test in an environment to measure radiated emissions (EMI). The FCC only requires the outdoor testing of devices. The equipment under test (EUT) was positioned to maximize the emissions.

INTERNAL TESTS

The equipment under test was performed on a wooden test bench, inside a screen room, 0.8m above the earth ground plane (see Figure 1). The EUT was powered through the Line Impedance Stabilization Network (LISN) bonded to the ground plane. The LISN power was filtered and the filter was bonded to the ground plane. The EUT was positioned on the table with the minimum distance from any conductive surface, as specified in MP-4. The excess power cord was wrapped in a figure-8 pattern to form a bundle approximately 8 cm in length. The EUT configuration was set for the highest emission frequency, and data was collected under the program control of the host computer. The spectrum analyzer collected the maximum peak readings over each spectrum. The six highest emission levels and corresponding frequencies were sorted and are listed in Table 1.

Frequency (MHz)	Emission Level dBuV	Emission Level uV	Specification Limit uV	
0.5345	33.2	46	250	
7.085	33.1	45	250	
10.08	33.1	45	250	
10.42	33.3	46	250	
11.62	33.4	47	250	
13.41	33.8	49	250	

TABLE 1: CONDUCTED EMISSIONS RESULTS

While in the screen room additional analyses on the device was done. First a local probe was used to test the emission levels around the board and device. There were no measurable emissions at the I/O pins or their corresponding trace lines. Emissions were measured at the jack to the power supply. The power supply and cord were the greatest source of emissions for the EUT. This is due to the power cord being an antenna which emitted the noise from the power supply. Designers should attempt to minimize antennas, which emit EMI. Antennas could be the power supply cord, as well as traces on the system board.

Second the PIC16C54A was monitored for susceptibility, following the IEC 801-3 specification. This test was measured from 27 MHz to 500 MHz in 10 KHz steps. The device did not display any signs of susceptibility (see Table 2).

EXTERNAL TESTS

The open field site used for radiated emission testing was setup according to the FCC bulletin OST 55. Figure 2 shows the layout of the open field test site. The EUT was mounted on a turntable. The position of the turntable is remote controlled to determine the highest emission levels. Initial testing was done with a broad band mounted on the antenna mast distance of 3 meters. Further investigation was done to determine the EUT positions that produced the maximum level of emissions. The receiving antenna was mounted on the antenna mast. The antenna height was varied to find the highest level of radiated emissions at each frequency. The six highest emission levels and corresponding frequencies were sorted and are listed in Table 3. Figures 3 and 4 show the dBuV vs. MHz graphs.

TABLE 2: RADIATED SUSCEPTIBILITY

Frequency (MHz)	SPEC V/M	Threshold V/M	Modulation	Comments	
27.0 - 500.0 †	3.0	> 3.0	80%	No Susceptibility	

† Frequency incremmented in 10 KHz steps

Frequency	Meter Reading (dBuV)	Antenna Factor dB	Effective Gain dB	Distribution Factor dB	Corr. Rdg dBuV/m	Corr. Rdg. uV/m	Spec Limit uV/m
36.01	53.1	11.8	34.0	0	30.9	35	100
40.04	53.0	11.3	34.2	0	30.1	32	100
44.04	56.1	11.1	34.0	0	33.2	46	100
48.04	55.1	11.0	33.7	0	32.4	42	100
64.05	55.2	9.0	33.9	0	30.3	33	100
112.05	56.0	10.6	33.4	0	33.2	46	150

TABLE 3: RADIATED EMISSIONS RESULTS





FIGURE 2



© 1994 Microchip Technology Inc.

CONCLUSION

The PIC16C54A device can be implemented into system designs that are required to be certified to the FCC Class B specification limits as defined by the FCC Title 47, Part 15 Subpart B and IEC 801-3 susceptibility.

APPENDIX A: TEST SETUPS







FIGURE 4: RADIATED EMISSIONS TEST SETUP FOR SITE "A"

OHMMETER Board Setup: Stan D'Souza Written By: Mark Palmer Testing By: Compatible Electronics 2

NOTES:

WORLDWIDE SALES & SERVICE

AMERICAS

Corporate Office

Microchip Technology Inc. 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 602 786-7200 Fax: 602 786-7277 Technical Support: 602 786-7627 Web: http://www.mchip.com/microhip

Atlanta

Microchip Technology Inc. 500 Sugar Mill Road, Suite 200B Atlanta, GA 30350 Tel: 770 640-0034 Fax: 770 640-0307 Boston Microchip Technology Inc. 5 Mount Royal Avenue Marlborough, MA 01752 Tel: 508 480-9990 Fax: 508 480-8575 Chicago Microchip Technology Inc. 333 Pierce Road, Suite 180 Itasca, IL 60143 Tel: 708 285-0071 Fax: 708 285-0075 Dallas Microchip Technology Inc. 14651 Dallas Parkway, Suite 816 Dallas, TX 75240-8809 Tel: 214 991-7177 Fax: 214 991-8588 Dayton Microchip Technology Inc. 35 Rockridge Road Englewood, OH 45322 Tel: 513 832-2543 Fax: 513 832-2841 Los Angeles Microchip Technology Inc. 18201 Von Karman, Suite 455 Irvine, CA 92715 Tel: 714 263-1888 Fax: 714 263-1338 **New York** Microchip Technology Inc. 150 Motor Parkway, Suite 416 Hauppauge, NY 11788 Tel: 516 273-5305 Fax: 516 273-5335

AMERICAS (continued)

San Jose

Microchip Technology Inc. 2107 North First Street, Suite 590 San Jose, CA 95131 Tel: 408 436-7950 Fax: 408 436-7955

ASIA/PACIFIC

Hong Kong Microchip Technology Unit No. 3002-3004, Tower 1 Metroplaza 223 Hing Fong Road Kwai Fong, N.T. Hong Kong Tel: 852 2 401 1200 Fax: 852 2 401 3431 Korea Microchip Technology 168-1, Youngbo Bldg. 3 Floor Samsung-Dong, Kangnam-Ku, Seoul, Korea Tel: 82 2 554 7200 Fax: 82 2 558 5934 Singapore Microchip Technology 200 Middle Road #10-03 Prime Centre Singapore 188980 Tel: 65 334 8870 Fax: 65 334 8850 Taiwan Microchip Technology 10F-1C 207

Tung Hua North Road Taipei, Taiwan, ROC Tel: 886 2 717 7175 Fax: 886 2 545 0139

EUROPE

United Kingdom Arizona Microchip Technology Ltd. Unit 6, The Courtyard Meadow Bank, Furlong Road Bourne End, Buckinghamshire SL8 5AJ Tel: 44 0 1628 851077 Fax: 44 0 1628 850259 France Arizona Microchip Technology SARL 2 Rue du Buisson aux Fraises

91300 Massy - France Tel: 33 1 69 53 63 20 Fax: 33 1 69 30 90 79 Germany Arizona Microchip Technology GmbH

Gustav-Heinemann-Ring 125 D-81739 Muenchen, Germany Tel: 49 89 627 144 0 Fax: 49 89 627 144 44 Italy

Arizona Microchip Technology SRL Centro Direzionale Colleoni Palazzo Pegaso Ingresso No. 2 Via Paracelso 23, 20041 Agrate Brianza (MI) Italy Tel: 39 039 689 9939 Fax: 39 039 689 9883

JAPAN

Microchip Technology Intl. Inc. Benex S-1 6F 3-18-20, Shin Yokohama Kohoku-Ku, Yokohama Kanagawa 222 Japan Tel: 81 45 471 6166 Fax: 81 45 471 6122

9/22/95

All rights reserved. © 1995, Microchip Technology Incorporated, USA.

Information contained in this publication regarding device applications and the like is intended through suggestion only and may be superseded by updates. No representation or warranty is given and no liability is assumed by Microchip Technology Incorporated with respect to the accuracy or use of such information, or infringement of patents or other intellectual property rights arising from such use or otherwise. Use of Microchip's products as critical components in life support systems is not authorized except with express written approval by Microchip No licenses are conveyed, implicitly or otherwise, under any intellectual property rights. The Microchip logo and name are registered trademarks of Microchip Technology Inc. All rights reserved. All other trademarks mentioned herein are the property of their respective companies.